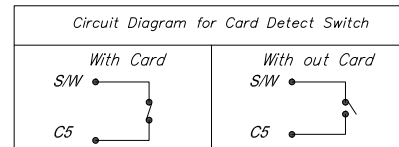
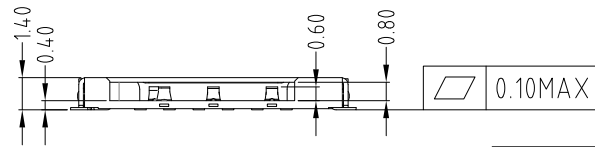
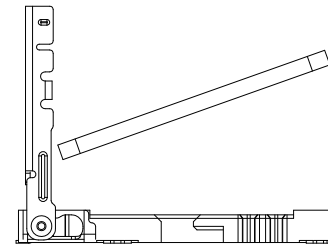


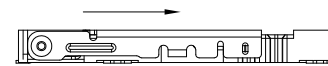
P.C.B LAYOUT MOUNTING PATTERN



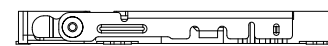
PIN NO.	PIN NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
S/W	SWTSH PIN



STEP 1 INSERT NANO SIM CARD



STEP 2 PUSH THE SHELL



STEP 3 FINISH

SPECIFICATION:

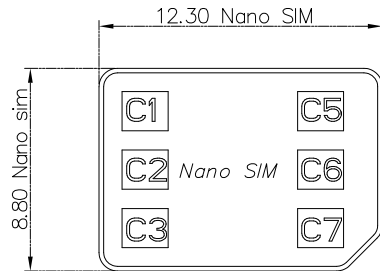
- CURRENT RATING : 0.5 mA AC / DC MAX.
- VOLTAGE RATING : 5V AC / DC
- INSULATION RESISTANCE : 100MΩ MIN.
- CONTACT RESISTANCE : 80mΩ MAX.
- OPERATING TEMPERATURE : -40°C TO +85°C.
- STORAGE TEMPERATURE : -40°C TO +85°C.
- LIFE : 5000 CYCLES

MATERIALS:

- HOUSING : LCP
- CONTACT : PHOSPHOR BRONZE
- SHELL : SUS

Finish:

- Finish: CONTACT: PLATED GOLD IN MATING AREA ; GOLD PLATED ON SOLDER BALLS ; NICKEL UNDER PLATED OVERALL
- SHELL: NICKEL UNDER PLATED SURFACE LAYER



ITEM NO.	DESCRIPTION	DRAWN	DATE
6	更新樣式	Jack	032024
5	更新樣式	Jack	022924
4	新增半整度標示	Jack	072723
3	新增pin編號	Jack	091322
2	更新料號	Jack	070522
1	更新OPERATING TEMPERATURE	Jack	080621



TOLERANCE UNLESS OTHERWISE STATED :  
 Up to 5 ±0.2  
 Above 5 ~ 15 ±0.3  
 Above 15 ~ 30 ±0.4  
 Above 30 ~ 50 ±0.5  
 Angle ±0.3

3RD. ANGEL'S



UNITS MM

DRAWN BY:	DATE
Jack Lu	03/20/24
CHECKED BY:	DATE
Jacky Chen	03/20/24
APPROVED BY:	DATE
Tony Kao	03/20/24

MAT'L	TITLE	CONNECTOR
FINISH	MODLE	Nano SIM CARD 掀蓋 1.40H 7P 帶開關
SCALE	1 : 1	DWG NO. NSIM-SFB007R-S267
SHEET NO.	1 of 1	PART NO. NSIM-SFB007R-S267

SIZE
A4
VER
R6